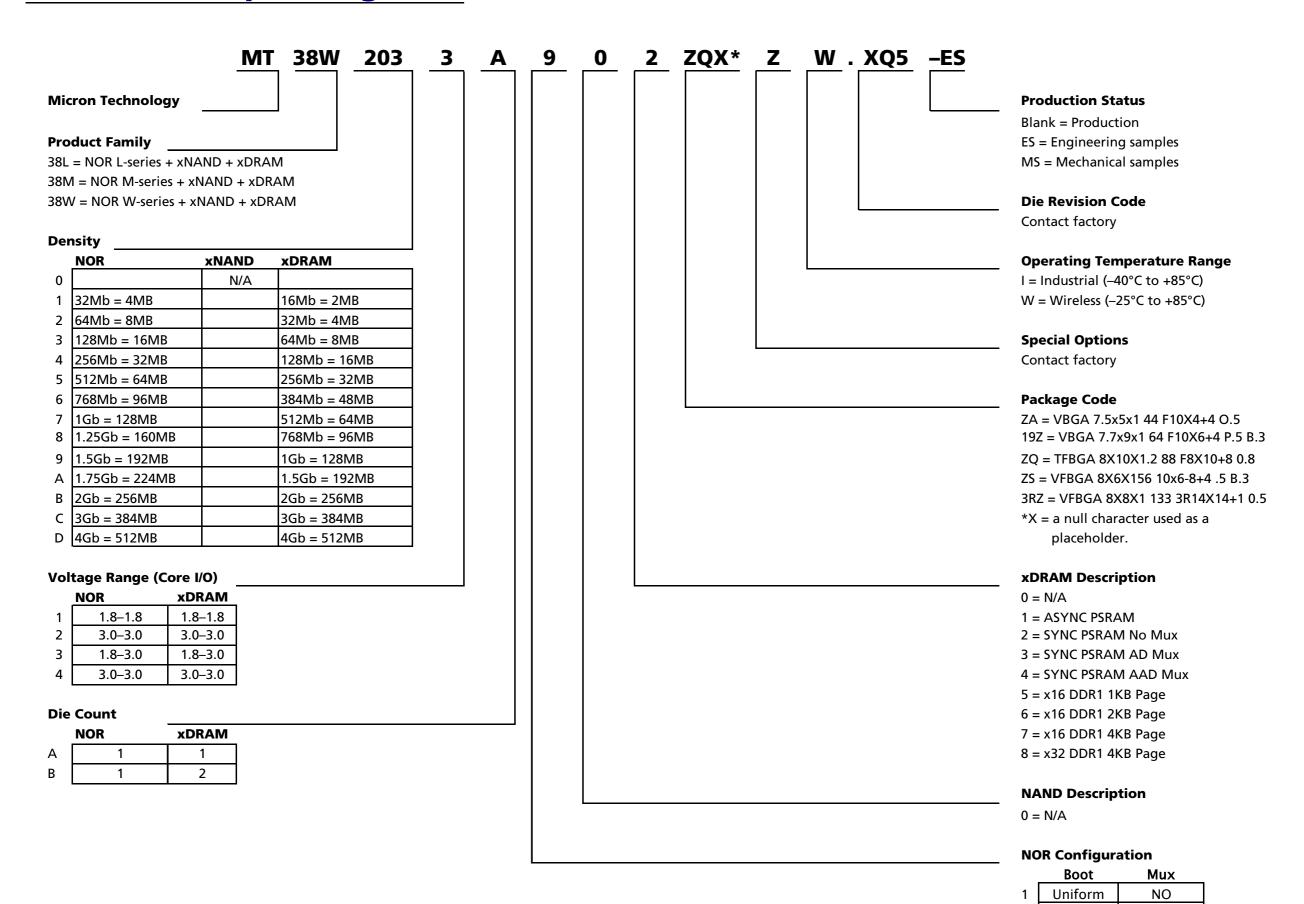
NOR MCP Part Numbering System

Micron's part numbering system is available at www.micron.com/numbering

Multichip Packages



AD

AD/AAD*

AAD

NO

ΑD

AD/AAD** AAD

NO

ΑD

AD/AAD* AAD

Uniform

Uniform

Uniform

Bottom

Bottom

Bottom

Bottom

Top

Top

Top

Top

8

9

Α

В

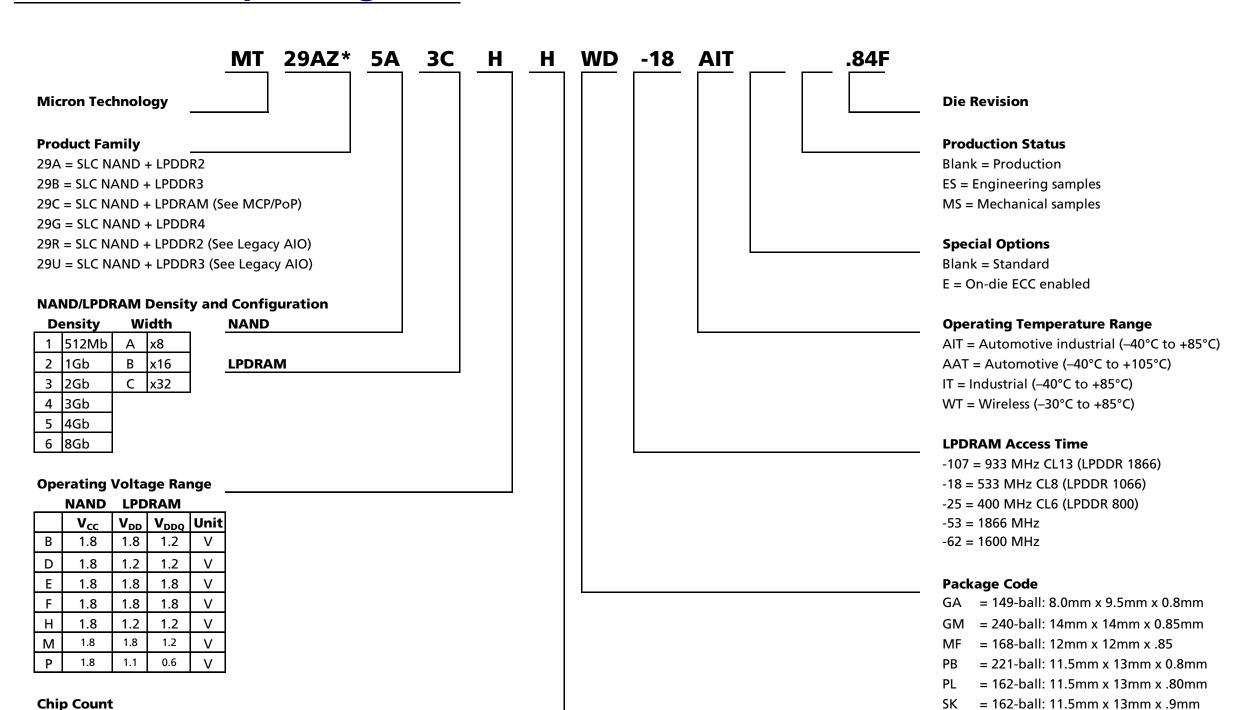


^{**}AAD interface configurable through register.

NAND MCP Part Numbering System

Micron's part numbering system is available at www.micron.com/numbering

Multichip Packages



G = 1 NAND Flash; 1 LPDRAM H = 1 NAND Flash; 2 LPDRAM I = 2 NAND Flash; 2 LPDRAM

M = 2 NAND Flash; 1 LPDRAM



= 162-ball: 8mm x 10.5mm x 0.9mm

TN = 121-ball: 7.5mm x 8mm x 0.8mm

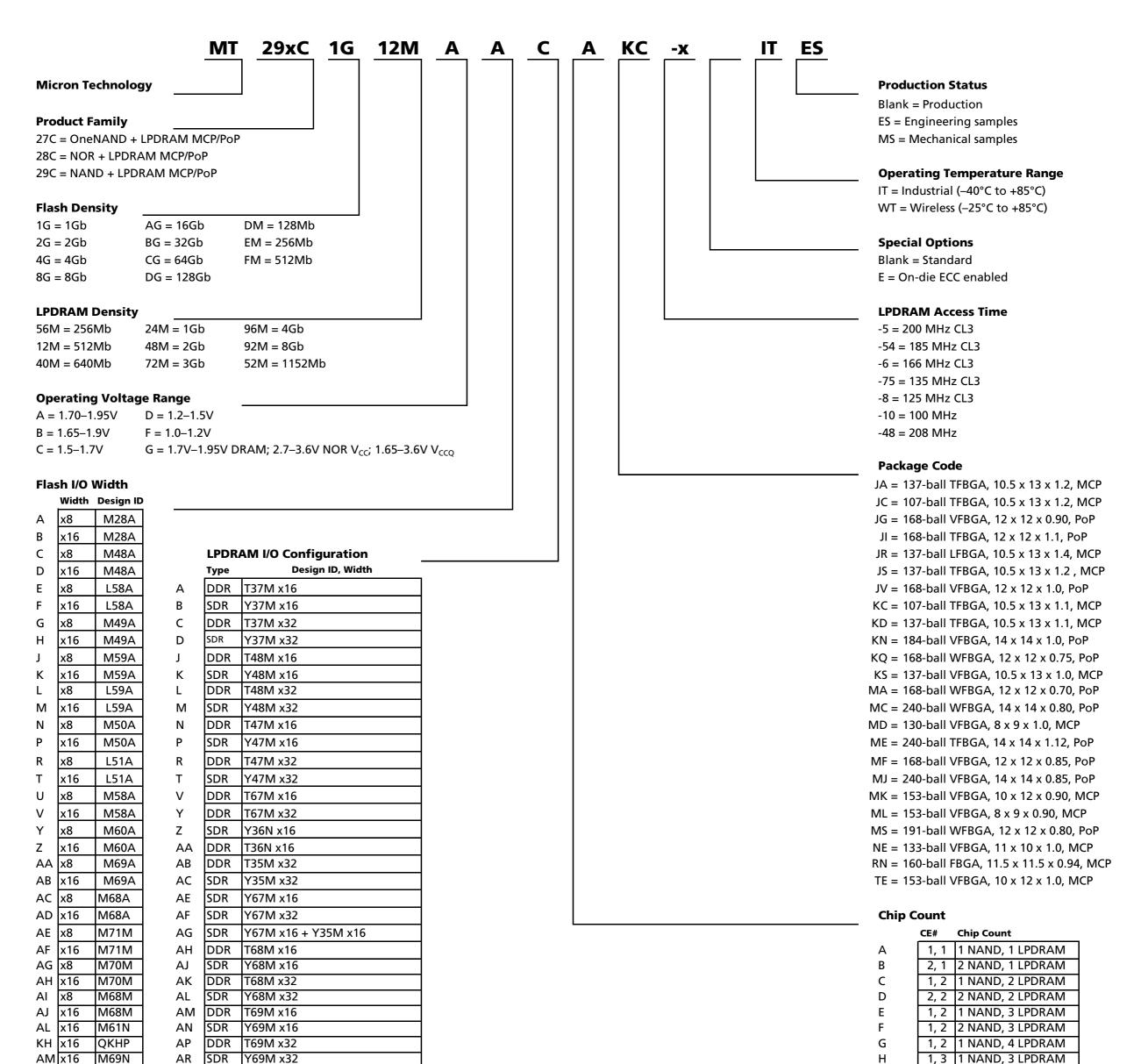
WD = 162-ball: 8.0mm x 10.5mm x 0.9mm

^{*}Z = a null character used as a placeholder.

MCP/PoP Part Numbering System

Micron's part numbering system is available at www.micron.com/numbering

Multichip Packages





ΑK

x16

3F0S

ΑS

ΑT

ΑU

AV

AY

AZ

BA

BB

SDR

DDR

DDR

SDR

DDR

DDR

DDR

DDR

Y47M x16 (2) + Y35M x16

T48M x16 (2) + T48M x32

T69M x32 + T68M x32

T36N x32 Y36N x32

T79M x16

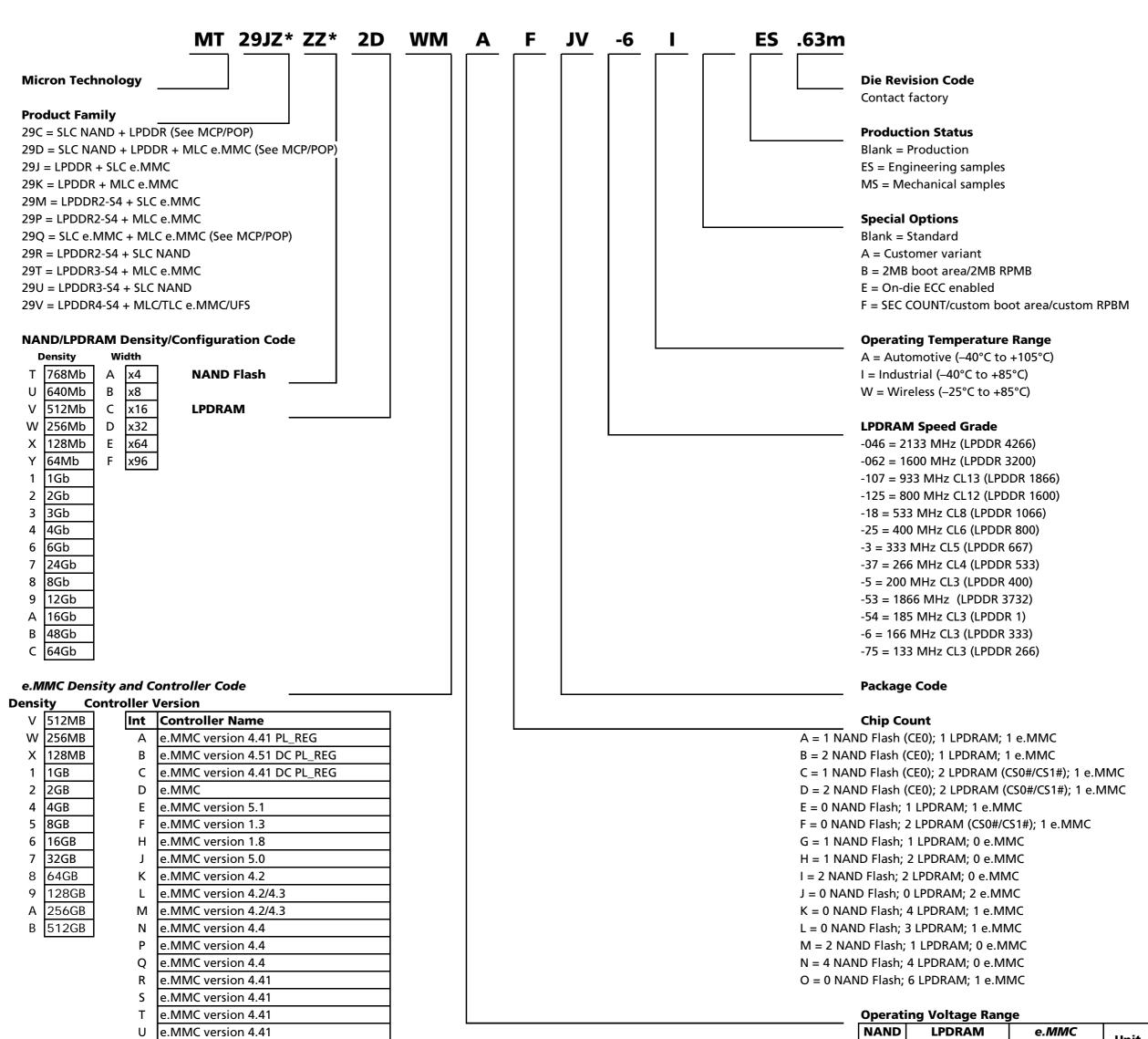
T79M x32

T89M x32

All-in-One Part Numbering System

Micron's part numbering system is available at www.micron.com/numbering

AiO Packages



*Z = a null character used as a placeholder.

W

e.MMC version 4.5

e.MMC version 4.5

e.MMC version 4.41

e.MMC version 5.0

 V_{DD} V_{DDQ} V_{CCM} N/A 1.8 1.8 1.2 1.8 1.8 1.8 1.35 1.2 1.8 1.8 1.2 1.2 1.8 1.8 1.8 1.8 3.3 1.8 1.8 1.8 1.8 1.8 1.8/1.2 Н 1.2 N/A N/A 1.2 1.2 1.8 1.2 1.2 3.3 N/A N/A N/A 3.3 1.8 1.2 1.8 3.3 1.2 1.2 N/A 1.1 1.1 N/A 0.6 3.3 1.1 3.3

Α

В

C

D

Ε

F

G

J Κ

M

Ν

Q

Unit

V

٧

٧

٧

V

V

 V_{CCQM}

1.8

1.8

1.8

1.8

1.8/3.3

1.8

1.8/3.3

N/A

1.8

1.8/3.3

1.8/3.3 N/A

N/A

1.8

1.8

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